

PI2121-EVAL1 Full-Function Active ORing Evaluation Board User Guide

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PI2121-EVAL1 Evaluation Board featuring the Cool-ORing PI2121 Full-Function Active ORing Solution.

The PI2121-EVAL1 Evaluation Board is intended to acquaint the user with the benefits and features of the Cool-ORing™ PI2121 full function Active ORing solution. It is not designed to be installed in end-use equipment.

Please read this document before setting up the PI2121-EVAL1 Evaluation Board and refer to the PI2121 product data sheet for device specifications, functional description and characteristics.

During operation, the power devices and surrounding structures can be operated safely at high temperatures.

- Remove power and use caution when connecting and disconnecting test probes and interface lines to avoid inadvertent short circuits and contact with hot surfaces.
- When testing electronic products always use approved safety glasses. Follow good laboratory practice and procedures.

Introduction

The PI2121-EVAL1 allows the user to test the basic principle and operational characteristics of an Active ORing function in a redundant power architecture, while also experiencing the benefits and value of the PI2121 solution versus conventional Active ORing solutions. The PI2121-EVAL1 evaluation board is configured to receive two independent power source inputs, per a typical redundant power architecture, through two Active ORing channels that are combined to form a redundant power output. Each channel is capable of up to 24 A, and is suitable for redundant bus voltages up to 5 V. For high current Active ORing, above 24 A, the two channels provided on the evaluation board can be paralleled in a master/slave configuration and OR'd with a second evaluation board.

The PI2121-EVAL1 evaluation board is designed with optimized PCB layout and component placement to represent a realistic high density final design for an embedded Active ORing solution for ≤ 5V bus applications requiring up to 24 A. This evaluation board is intended as an easy and simple way to test the electrical and thermal performance of the PI2121 Full-Function Active ORing solution.

Both dynamic and steady state testing of the PI2121 can be completed on the PI2121-EVAL1 evaluation board, in addition to using the key features of the product. Dynamic testing can be completed under a variety of system level fault conditions to check for response time to faults.

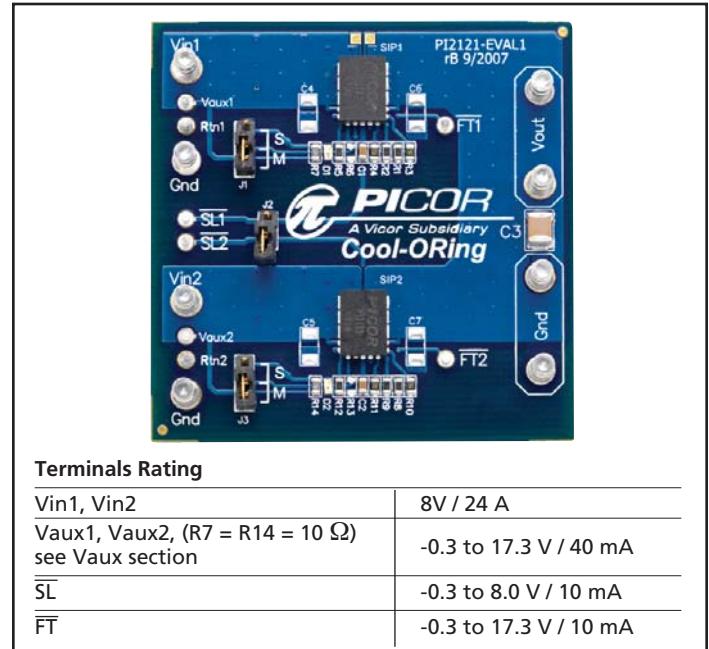
This document provides basic instructions for initial start-up and configuration of the evaluation board. Further information on the functionality of the PI2121 can be found in the PI2121 product data sheet.

Cool-ORing™ PI2121 Product Description

The Cool-ORing PI2121 is a complete full-function Active ORing solution with a high-speed ORing MOSFET controller and a very low on-state resistance MOSFET designed for use in redundant power system architectures. The PI2121 Cool-ORing solution is offered in an extremely small, thermally enhanced 5 mm x 7 mm LGA package and can be used in low voltage (≤ 5 Vbus) high side Active ORing applications. The PI2121 enables extremely low power loss with fast dynamic response to fault conditions, critical for high availability systems. A master/slave feature allows the paralleling of PI2121 solutions for high current Active ORing requirements.

The PI2121, with its 1.5 m Ω internal MOSFET provides very high efficiency and low power loss during steady state operation, while achieving high-speed turn-off of the internal MOSFET during input power source fault conditions that cause reverse current flow. The PI2121 provides an active low fault flag output to the system during excessive forward current, light load, reverse current, over-voltage, under-voltage, and over-temperature fault conditions. A temperature sensing function indicates a fault if the maximum junction temperature exceeds 160°C. The under-voltage and over-voltage thresholds are programmable via an external resistor divider.

Figure 1 shows a photo of the PI2121-EVAL1 evaluation board, with two PI2121 used to form the two Active ORing channels. The board is built with two identical Active ORing circuits with options and features that enable the user to fully explore the capabilities of the PI2121 Cool-ORing solution.



Terminals Rating

Vin1, Vin2	8V / 24 A
Vaux1, Vaux2, (R7 = R14 = 10 Ω) see Vaux section	-0.3 to 17.3 V / 40 mA
SL	-0.3 to 8.0 V / 10 mA
FT	-0.3 to 17.3 V / 10 mA

Figure 1 – PI2121-EVAL1 Evaluation Board (1.8" x 1.8")

Terminal	Description
Vin1	Power Source Input #1 or bus input designed to accommodate up to 24 A continuous current.
Vaux1	Auxiliary Input Voltage #1 to supply PI2121 (SiP1) VC power. Vaux1 should be equal to Vin1 plus 5 V or higher. See details in Auxiliary Power Supply (Vaux) section of the PI2121 data sheet.
Rtn1	Vaux1 Return Connection: Connected to Ground plane
Gnd	Vin & Vout Return Connection: Three Gnd connections are available and are connected to a common point, the Ground plane. Input supplies Vin1 & Vin2 and the output load at Vout should all be connected to their respective local Gnd connection.
SL1	PI2121 (SiP1) Slave Input-Output Pin: For monitoring SiP1 slave pin. When SiP1 is configured as the Master, this pin functions as an output that drives slaved PI2121 devices. When SiP1 is configured in Slave mode, SL1 serves as an input.
SL2	PI2121 (SiP2) Slave Input-Output Pin: For monitoring SiP2 slave pin. When SiP2 is configured as the Master, this pin functions as an output that drives slaved PI2121 devices. When SiP2 is configured in Slave mode, SL2 serves as an input.
Vin2	Power Source Input #2 or bus input designed to accommodate up to 24 A continuous current.
Vaux2	Auxiliary Input Voltage #2 to supply PI2121 (SiP2) VC power. Vaux2 should be equal to Vin2 plus 5 V or higher. See details in Auxiliary Power Supply (Vaux) section of the PI2121 data sheet.
Rtn2	Vaux2 Return Connection: Connected to Ground plane
FT1	PI2121 (SiP1) Fault Pin: Monitors SiP1 fault conditions
FT2	PI2121 (SiP2) Fault Pin: Monitors SiP2 fault conditions
Vout	Output: SiP1 and SiP2 D pins connection, connect to the load high side.

Table 1 – PI2121-EVAL1 Evaluation Board terminals description

Jumper	Description
J1, J3	BK Jumpers: Connect jumper across M for master mode and across S for slave mode. Remove jumper to adjust reverse fault blanking time using Rbk. Rbk is R6 for SiP1 and R13 for SiP2 shown in the schematic, Figure 2.
J2	Slave Jumper: Remove the jumper unless one of the PI2121 is configured in slave mode.

Table 2 – PI2121-EVAL1 Evaluation Board jumpers description

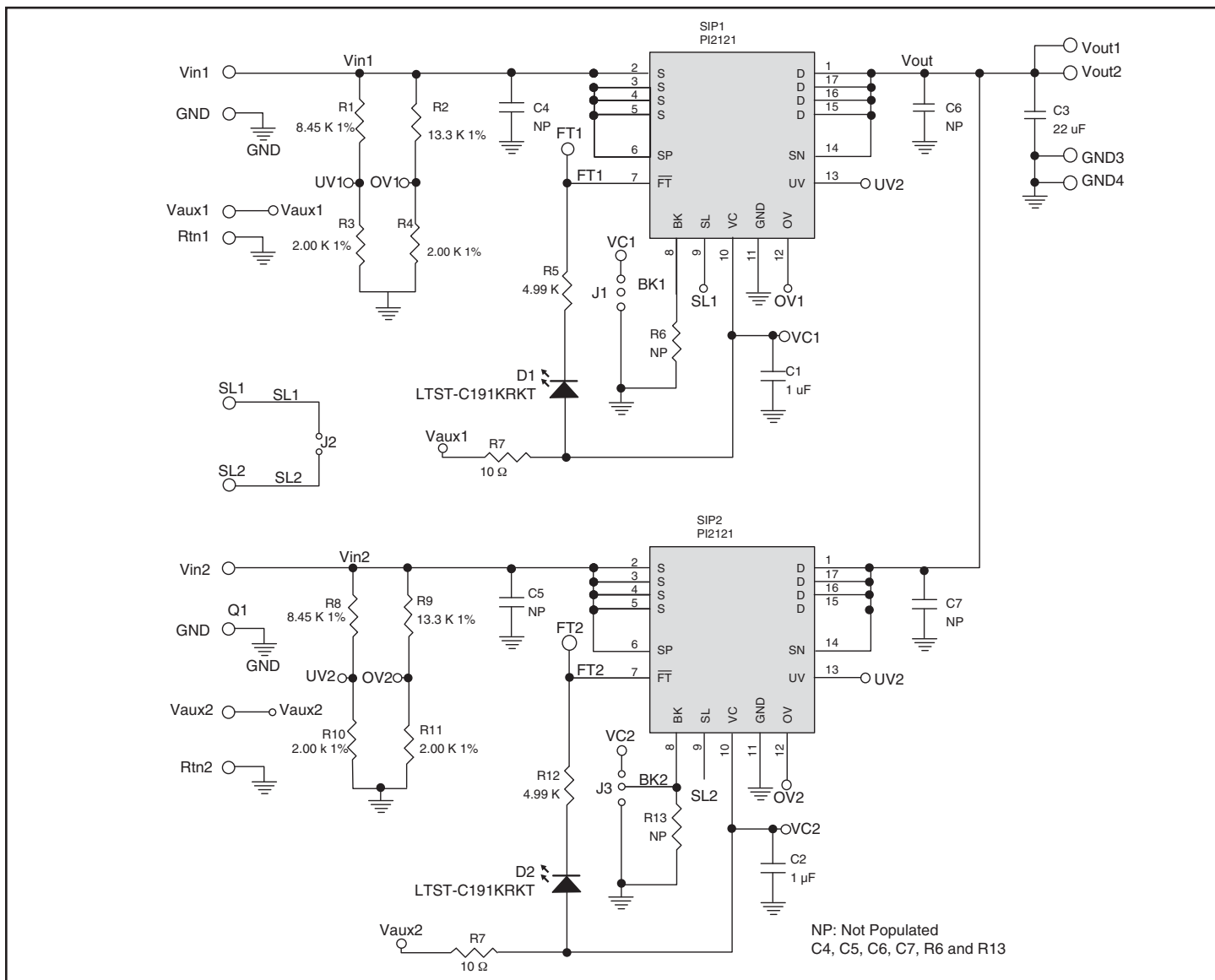


Figure 2 – PI2121-EVAL1 Evaluation Board schematic.

Item	QTY	Reference Designator	Value	Description	Footprint	Manufacturer
1	2	C1, C2	1 μ F	Capacitor, MLCC X5R, 1 μ F, 16 V	0603	
2	1	C3	22 μ F	Capacitor, MLCC X7R, 22 μ F, 25 V	1210	
3	4	C4, C5, C6, C7	Not installed		1206	
4	2	D1, D2		LED, Super Red	THIN 0603	Lite-On, Inc.,
5	8	FT1, FT2, Rtn1, Rtn2, SL1, SL2, Vaux1, Vaux2		Turret Test point	TURRET-1528	Keystone Electronics
6	7	Gnd1, Gnd2, Gnd3, Gnd4, Vin1, Vin2, Vout1, Vout2		Turret Test point	TURRET-1502	Keystone Electronics
7	2	J1, J3		Header Pins 0.1" pitch	2 x 3mm	
8	1	J2		Header Pins 0.1" pitch	2 x 2mm	
9	2	R1, R8	8.45 K Ω	Resistor, 8.45 K Ω , 1%	0603	
10	2	R2, R9	13.3 K Ω	Resistor, 13.3 K Ω , 1%	0603	
11	4	R3, R4, R10, R11	2.00 K Ω	Resistor, 2.00 K Ω , 1%	0603	
12	2	R5, R12	4.99 K Ω	Resistor, 4.99 K Ω , 1%	0603	
13	2	R6, R13	Not Installed		0603	
14	2	R7, R14	10	Resistor, 10, 5%	0603	
15	2	SiP1, SiP2	PI2121	Picor Full-Function 24 A Cool-ORing Solution	5x7mm; 17 pins	PICOR

Table 3 – PI2121-EVAL1 Evaluation Board bill of materials

Reference Designator	Value	Functional Description
C1, C2	1 μ F	VC Bypass Capacitor
C3	22 μ F	Output (Load) Capacitor
C4, C5, C6, C7	Not installed	Snubber to reduce voltage ringing when the device turns off
D1, D2	LED	To indicate a fault exist when it is on
J1, J3	Jumper	To select between Master and Slave Modes
J2	Jumper	Connection between $\overline{SL1}$ and $\overline{SL2}$
R1, R8	8.45K Ω	UV Voltage Divider Resistor ($R2_{UV}$ in Figure 4)
R2, R9	13.3K Ω	OV Voltage Divider Resistor ($R2_{OV}$ in Figure 4)
R3, R10	2.00K Ω	UV Voltage Divider Resistor ($R1_{UV}$ in Figure 4)
R4, R11	2.00K Ω	OV Voltage Divider Resistor ($R1_{OV}$ in Figure 4)
R5, R12	4.99K Ω	LED Current Limiter
R6, R13	Not Installed	BK Delay Timer Programmable Resistor
R7, R14	10 Ω	VC Bias Resistor
SiP1, SiP2	PI2121	Cool ORing SiP.

Table 4 – Component functional description

Initial Test Set Up

To test the PI2121-EVAL1 evaluation board it is necessary to configure the jumpers (J1, J2 and J3) first based on the required board configuration.

Failure to configure the jumpers prior to the testing may result in improper circuit behavior.

Baseline Test Procedure (Refer to Figure 3)

1.0 Recommended Equipment

- 1.1 Two DC power supplies - 0-10 V; 25 A.
- 1.2 DC power supply 12 V; 100 mA.
- 1.3 DC electronic load - 50 A minimum.
- 1.4 Digital Multimeter
- 1.5 Oscilloscope.
- 1.6 Appropriately sized interconnect cables.
- 1.7 Safety glasses.
- 1.8 PI2121 Product Data sheet.

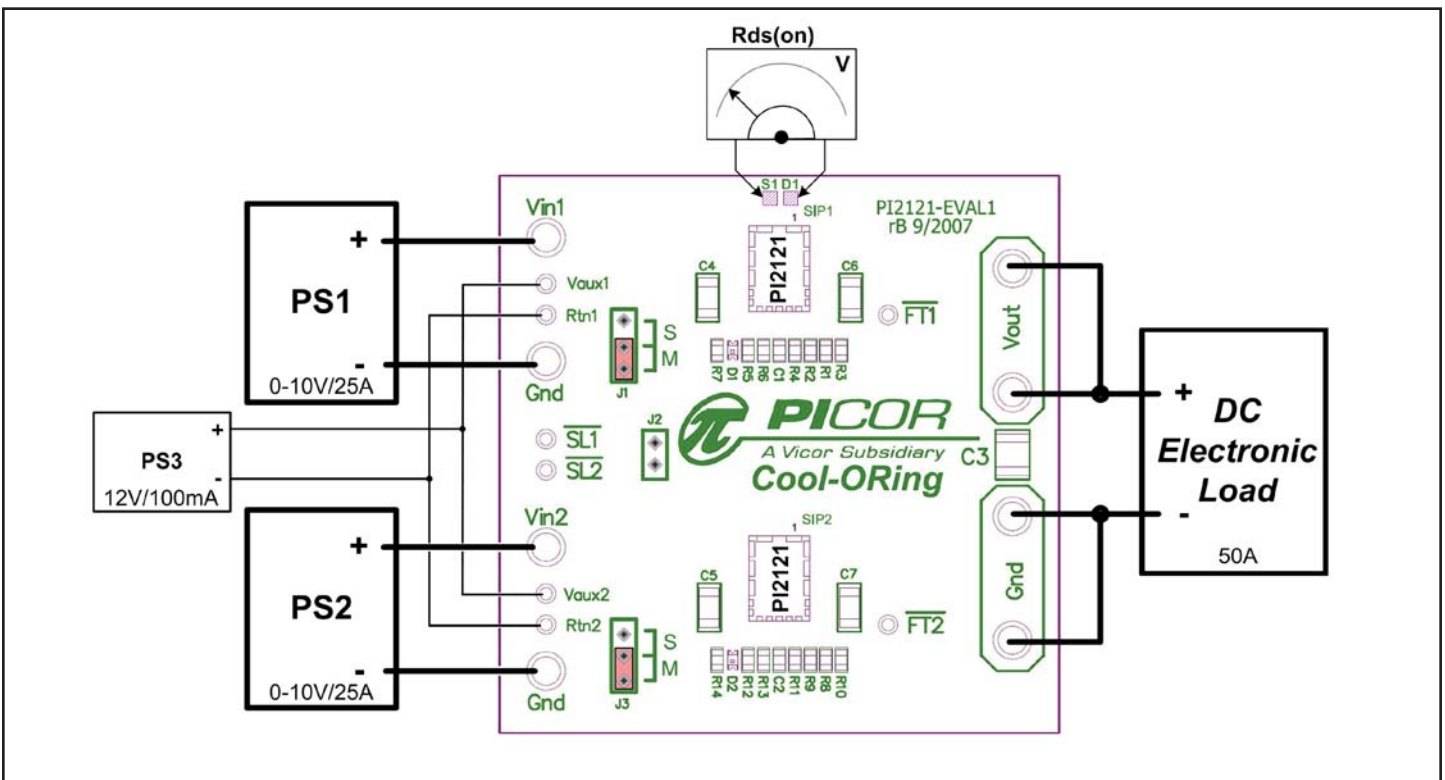


Figure 3 – Layout configuration for a typical redundant power application, using PI2121 with both solutions configured in Master Mode.

Before initial power-up follow these steps to configure the evaluation board for specific end application requirements:

2.0 Undervoltage (UV) and Overvoltage (OV) resistors set up:

2.1 UV and OV programmable resistors are configured for a 3.3 V V_{in} (BUS voltage) application in a two-resistor voltage divider configuration as shown in Figure 4. UV is set to 2.6 V and OV is set for 3.8 V, $R1_{OV}$ and $R1_{UV}$ are 2.00 K Ω 1%. If PI2121-EVAL1 is required to be used in a different V_{in} voltage application please follow the following steps to change the resistor values.

2.1.1 It is important to consider the maximum current that will flow in the resistor divider and maximum error due to UV and OV input current.

$$R1_{UV} = \frac{V(UV_{TH})}{I_{RUV}}$$

2.1.2 Set $R1_{UV}$ and $R1_{OV}$ value based on system allowable minimum current and 1% error; $I_{RUV} \geq 100 \mu A$

$$R2_{UV} = R1_{UV} \left(\frac{V(UV)}{V(UV_{TH})} - 1 \right)$$

Where:

$V(UV_{TH})$: UV threshold voltage

$V(UV)$: UV voltage set (0.5 V typ)

I_{RUV} : $R1_{UV}$ current

$$R2_{OV} = R1_{OV} \left(\frac{V(OV)}{V(OV_{TH})} - 1 \right)$$

Where:

$V(OV_{TH})$: OV threshold voltage

$V(OV)$: OV voltage set (0.5 V typ)

I_{ROV} : $R1_{OV}$ current

2.1.3 Example for 2.0 V V_{in} (BUS voltage), to set UV and OV for $\pm 10\%$ V_{in} set UV at 1.8 V and OV at 2.2 V.

$$R2_{UV} = R1_{UV} \left(\frac{V(UV)}{V(UV_{TH})} - 1 \right) = 2.00 \text{ K}\Omega * \left(\frac{1.8 \text{ V}}{0.5 \text{ V}} - 1 \right) = 5.20 \text{ K}\Omega \text{ (or } 5.23 \text{ K}\Omega \text{ \% standard value)}$$

$$R2_{OV} = R1_{OV} \left(\frac{V(OV)}{V(OV_{TH})} - 1 \right) = 2.00 \text{ K}\Omega * \left(\frac{2.2 \text{ V}}{0.5 \text{ V}} - 1 \right) = 6.80 \text{ K}\Omega \text{ (or } 6.81 \text{ K}\Omega \text{ \% standard value)}$$

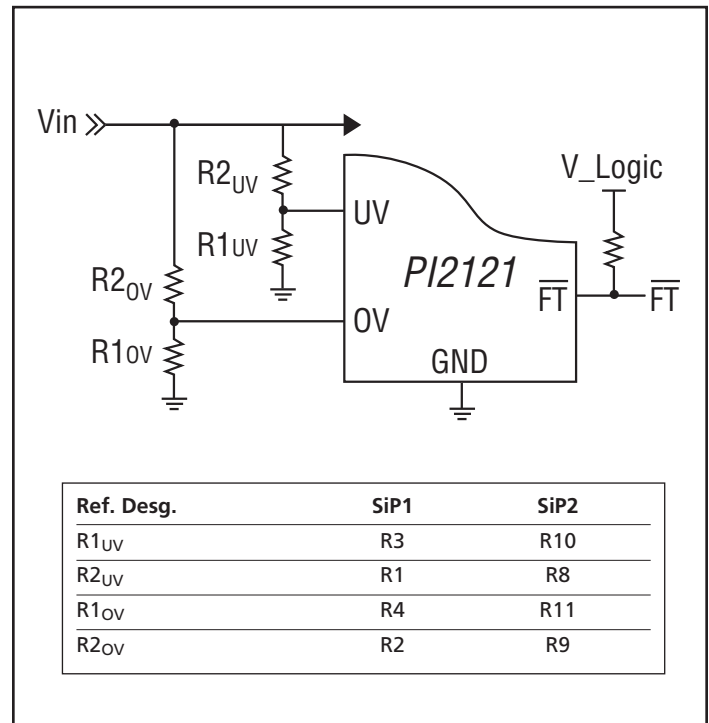


Figure 4 – UV & OV two-resistor divider configuration

3.0 Blanking timer setup:

3.1 The blanking timer provides noise filtering for typical switching power conversion that might cause premature reverse current detection by masking the reverse fault condition. The shortest blanking time is 50 ns when the BK pin is connected to ground. Connecting an external resistor (R_{BK} , reference designators R6 for SiP1 and R13 for SiP2) between the BK pin and ground will increase the blanking time as shown in Figure 5.

Where: $R_{BK} \leq 200 \text{ K}\Omega$

Note: When BK is connected to VC for slave mode operation, then the blanking time will be 270 ns typically.

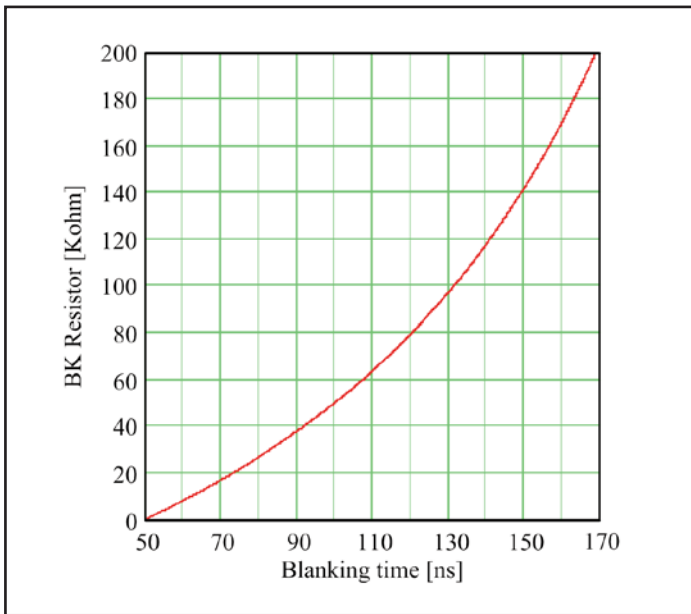


Figure 5 –BK Resistor selection versus Blanking Time

4.0 Auxiliary Power Supply (Vaux):

- 4.1 The PI2121 ORing solution has a separate input (VC) that provides power to the control circuitry and the internal gate driver. An internal voltage regulator (VC) clamps the VC voltage to 15.5 V typically.
- 4.2 Connect an independent power source to the Vaux inputs of PI2121-EVAL1 Evaluation Board to supply power to the VC inputs. The Vaux voltage should be 5 V higher than V_{in} (redundant power source output voltage) to fully enhance the internal MOSFET.
- 4.3 10Ω bias resistors (R_{bias} , reference designators R7 and R14) are installed on the PI2121-EVAL1 board between each Vaux input and VC pin of the PI2121 solution.
- 4.4 If Vaux is higher than the Clamp voltage, 15.5 V typical, the R_{bias} value has to be changed using the following equations:

4.4.1 Select the value of R_{bias} using the following equation:

$$R_{bias} = \frac{V_{aux_{min}} - V_{C_{clampMAX}}}{I_{C_{max}}}$$

4.4.2 Calculate R_{bias} maximum power dissipation:

$$P_{d_{R_{bias}}} = \frac{(V_{aux_{max}} - V_{C_{clampMIN}})^2}{R_{bias}}$$

Where:

$V_{aux_{min}}$: Vaux minimum voltage

$V_{aux_{max}}$: Vaux maximum voltage

$V_{C_{clampMAX}}$: Maximum controller clamp voltage, 16.0 V

$V_{C_{clampMIN}}$: Minimum controller clamp voltage, 14.0 V

$I_{C_{max}}$: Controller maximum bias current, use 4.2 mA

4.4.3 For example, if the minimum $V_{aux} = 22 \text{ V}$ and the maximum $V_{aux} = 28 \text{ V}$

$$R_{bias} = \frac{V_{aux_{min}} - V_{C_{clampMAX}}}{I_{C_{max}}} = \frac{22 \text{ V} - 16 \text{ V}}{4.2 \text{ mA}} = 1.429 \text{ K}\Omega$$

,use 1.43 $\text{K}\Omega$ 1% resistor

$$P_{d_{R_{bias}}} = \frac{(V_{aux_{max}} - V_{C_{clampMIN}})^2}{R_{bias}} = \frac{(28 \text{ V} - 14.0 \text{ V})^2}{1.43 \text{ K}\Omega} = 137 \text{ mW}$$

Note: Minimize the resistor value for low Vaux voltage levels to avoid a voltage drop that may reduce the VC voltage lower than required to drive the gate of the internal MOSFET.

5.0 Hook Up of the Evaluation Board

- 5.1 OV and UV resistors values are configured for a 3.3 V input voltage. If you are using the evaluation board in a different input voltage level you have to adjust the resistor values by replacing R1, R2, R8 and R9, or remove R2, R3, R9 and R10 to disable UV and OV. Please refer to the UV/OV section for details to set R1, R2, R8 and R9 proper values.
- 5.2 Verify that the jumpers J1 and J3 are installed for master mode [across M] and no Jumper on J2.
- 5.3 Connect the positive terminal of PS1 power supply to Vin1. Connect the ground terminal of PS1 to its local Gnd. Set the power supply to 3.3 V. Keep PS1 output disabled (OFF).
- 5.4 Connect the positive terminal of PS2 power supply to Vin2. Connect the ground terminal of PS2 to its local Gnd. Set the power supply to 3.3 V. Keep PS2 output disabled (OFF).
- 5.5 Connect the positive terminal of PS3 power supply to Vaux1 and Vaux2. Connect the ground terminal of this power supply to Rtn1 and Rtn2. Set the power supply to 12 V. Keep PS3 output disabled (OFF).
- 5.6 Connect the electronic load to the output between Vout and Gnd. Set the load current to 10 A.
- 5.7 Enable (turn ON) PS1 power supply output.
- 5.8 Turn on the electronic load.
- 5.9 Verify that the electronic load input voltage reading is one diode voltage drop below 3.3 V.
- 5.10 Enable (turn ON) PS3 power supply output.
- 5.11 Verify that the electronic load voltage reading increases to a few millivolts below 3.3 V. This verifies that the PI2121 (SiP1) internal MOSFET is in conduction mode.
- 5.12 D1 should be off. This verifies that there is no fault condition.
- 5.13 Reduce PS1 output voltage to 2 V,
- 5.14 D1 should turn on, this verifies that the circuit is in an under-voltage fault condition.
- 5.15 Increase PS1 output to 3.3 V, D1 should turn off, then increase PS1 output to 4 V, D1 should turn on indicating an over-voltage fault condition
- 5.16 Verify that Vin2 is at 0V. This verifies that the PI2121 (SiP2) internal FET is off.
- 5.17 D2 should be on. This is due to a reverse voltage fault condition caused by the bus voltage being high with respect to the input voltage (Vin2).
- 5.18 Enable (turn ON) PS2 output.
- 5.19 Verify that both PS1 and PS2 are sharing load current evenly by looking at the supply current.
- 5.20 Disable (turn OFF) PS1, PS2 and PS3 outputs.

- 5.21 Enable (turn ON) PS2 output then Enable PS3 output.
- 5.22 Verify that the electronic load voltage reading is few millivolts below 3.3 V. This verifies that the PI2121 (SiP2) internal MOSFET is in conduction mode.
- 5.23 D2 should be off. This verifies that there is no fault condition.
- 5.24 Reduce PS2 output voltage to 2 V,
- 5.25 D2 should turn on, this verifies that the circuit is in an under-voltage fault condition.
- 5.26 Increase PS2 output to 3.3 V, D2 should turn off, then increase PS2 output to 4 V, D2 should turn on indicating an over voltage fault condition.
- 5.27 Verify that Vin1 is at 0V. This verifies that the PI2121 (SiP1) internal FET is off.
- 5.28 D1 should be on. This is due to a reverse voltage fault condition caused by the bus voltage being high with respect to the input voltage (Vin1).

6.0 Slave Mode: Slave Mode can be demonstrated in two setups; either by using one PI2121-EVAL1 evaluation board as a single ORing function with both PI2121 effectively in parallel or two PI2121-EVAL1 evaluation boards to demonstrate a true redundant 48 A system. The following test steps uses a single PI2121-EVAL1 in a slave mode application.

Note: In this experiment SiP 1 is configured in master mode and SiP2 is configured in slave mode.

- 6.1 BK pin (J1) of the master device will be connected to ground [across M] while the slaved device BK pin (J3) is connected to VCC [across S]. Place a jumper across J2 to connect slave pins together.
- 6.2 Connect the positive terminal of PS1 power supply to Vin1. Connect the ground terminal of this power supply to Gnd. Set the power supply to 3.3 V. Keep PS1 output disabled (OFF).
- 6.3 Connect the positive terminal of PS2 power supply to Vin2. Connect the ground terminal of this power supply to Gnd. Set the power supply to 3.3 V. Keep PS2 output disabled (OFF).
- 6.4 Connect the positive terminal of PS3 power supply to Vaux1 and Vaux2. Connect the ground terminal of this power supply to Rtn1 and Rtn2. Set the power supply to 12 V. Keep PS3 output disabled (OFF).
- 6.5 Connect the electronic load between Vout and Gnd. Set the load current to 10 A.
- 6.6 Enable (Turn ON) PS2, and PS3 outputs, and keep PS1 output disabled (OFF).
- 6.7 Turn on the electronic load.

- 6.8 Verify that electronic load voltage drops to a diode drop below PS2. This verifies that the SiP2 internal FET is off due to the Master (SiP1) not being on.
- 6.9 Enable (turn on) PS1 output:
- 6.10 Verify that the electronic load input voltage reading is a few millivolts below 3.3 V and PS1 and PS2 are sharing the load current evenly. This verifies that both internal MOSFET's of SiP1 and SiP2 are in conduction mode.

7.0 Input short circuit test

- 7.1 To emulate a real application, the BUS supplies for this test should have a solid output source such as DC-DC converter that supplies high current and can be connected very close to the evaluation board to reduce stray parasitic inductance. Or use the prospective supply sources of the end application where the PI2121 will be used.
- 7.2 Stray parasitic inductance in the circuit can contribute to significant voltage transient conditions, particularly when the internal MOSFET is turned-off after a reverse current fault has been detected. When a short is applied at the output of the input power sources and the evaluation board input (Vin), a large reverse current is sourced from the

evaluation board output through the ORing internal MOSFET. The reverse current in the MOSFET may reach over 60 A in some conditions before the MOSFET is turned off. Such high current conditions will store high energy even in a small parasitic element, and can be represented as $\frac{1}{2} L i^2$. A 1 nH parasitic inductance with 60 A reverse current will generate 1.8 μJ. When the MOSFET is turned off, the stored energy will be released and will produce a high negative voltage at the MOSFET source and high positive voltage at the MOSFET drain. This event will create a high voltage difference across the drain and source of the MOSFET.

- 7.3 Apply a short at one of the inputs (Vin1 or Vin2) when the evaluation board is configured with both SiP's (SiP1 and SiP2) in master mode. The short can be applied electronically using a MOSFET connected between Vin and Gnd or simply by connecting Vin to Gnd. Then measure the response time between when the short is applied and the SiP internal MOSFET is disconnected (or turned off). An example for PI2121 response time to an input short circuit is shown in Figure 6.

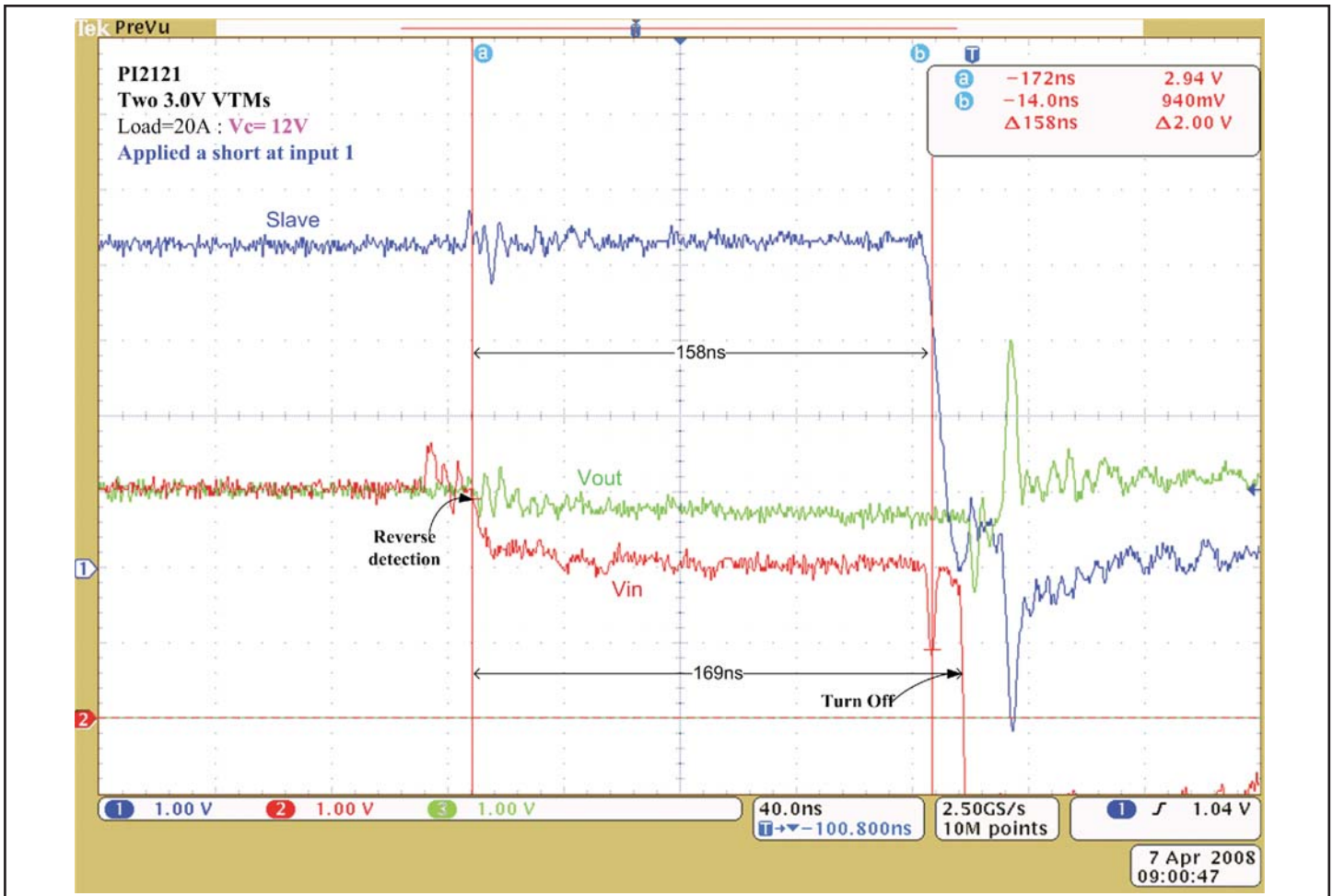


Figure 6 – Plot of PI2121 response time to reverse current detection

8.0 Internal MOSFET Rds(on) Measurement:

8.1 The SiP1 internal MOSFET Rds(on) can be measured with a voltmeter between the S1 and D1 Kelvin connection. The potential between S1 and D1 is the voltage drop across the internal MOSFET and:

$$R_{ds(on)} = \frac{V_{S1} - V_{D1}}{I_{in}}$$

Where:

V_{S1}-V_{D1}: Voltage drop across the internal MOSFET

I_{in}: Input current.

Note: The Rds(on) value is temperature dependent and the junction temperature increases directly proportional to power dissipation.

Thermal Images

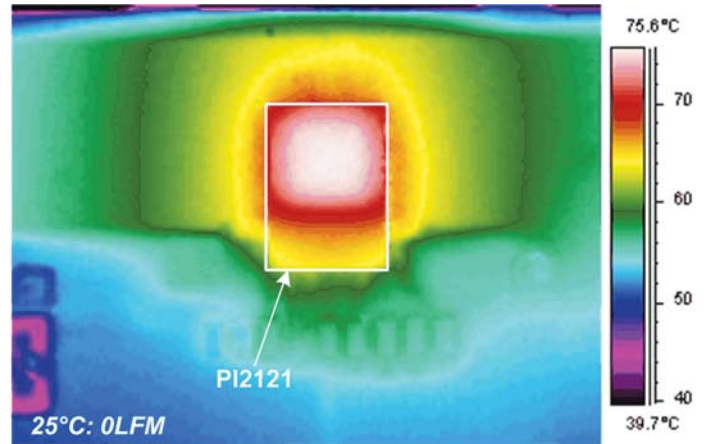


Figure 7a – PI2121 mounted on PI2121-EVAL1, I_{out}=24 A, T_A=25°C, Air Flow=0 LFM

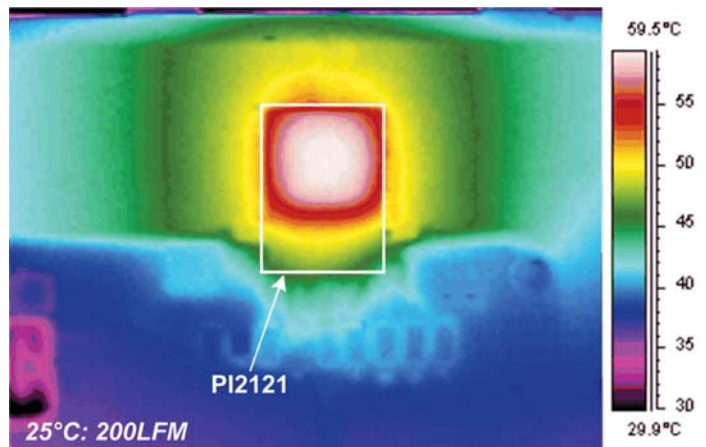


Figure 7b – PI2121 mounted on PI2121-EVAL1 I_{out}=24 A, T_A=25°C, Air Flow=200 LFM

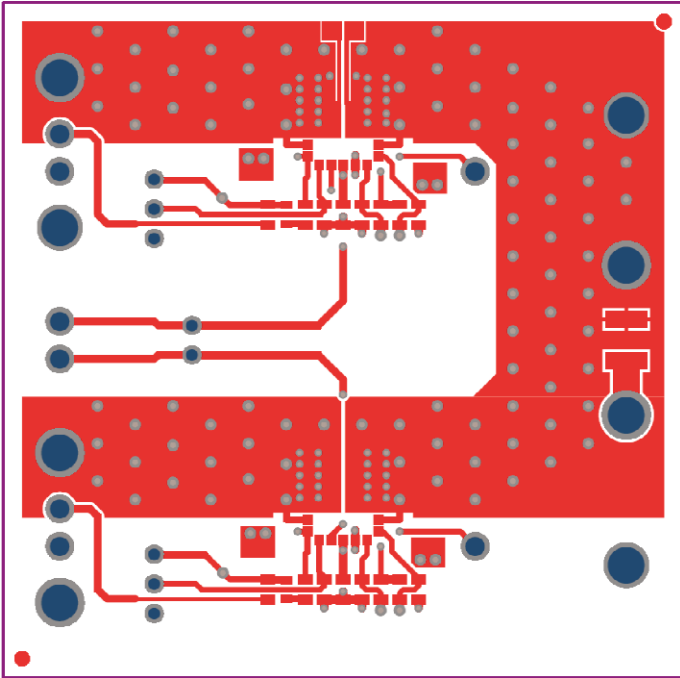


Figure 8a – PI2121-EVAL1 layout top layer. Scale 2.0:1

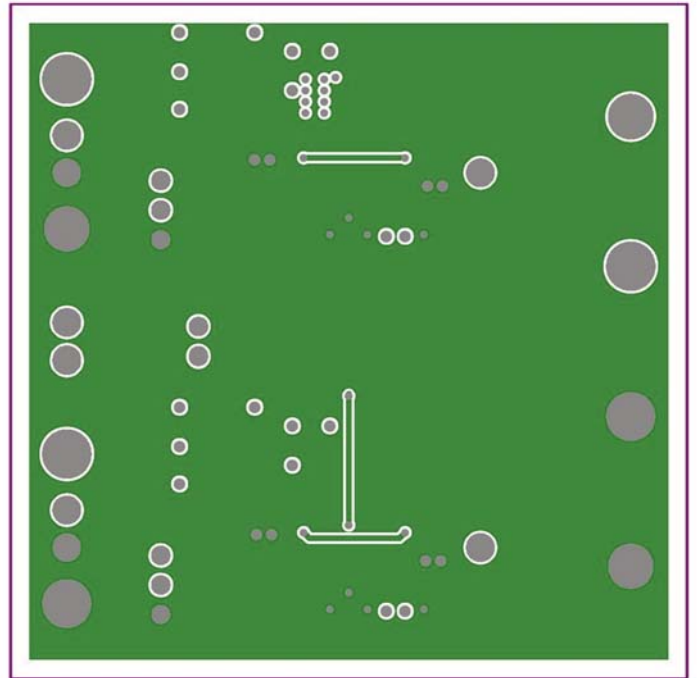


Figure 8b – PI2121-EVAL1 layout mid layer 2. Scale 2.0:1

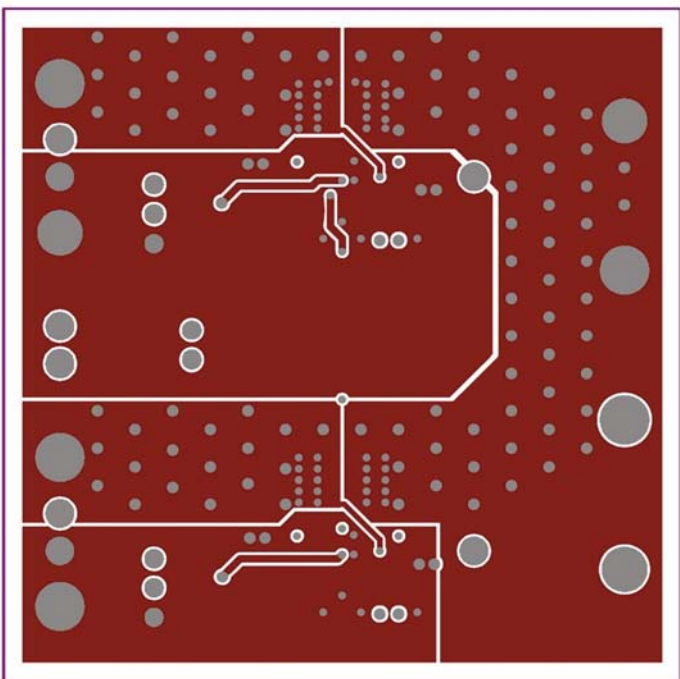


Figure 8c – PI2121-EVAL1 layout mid layer 1. Scale 2.0:1

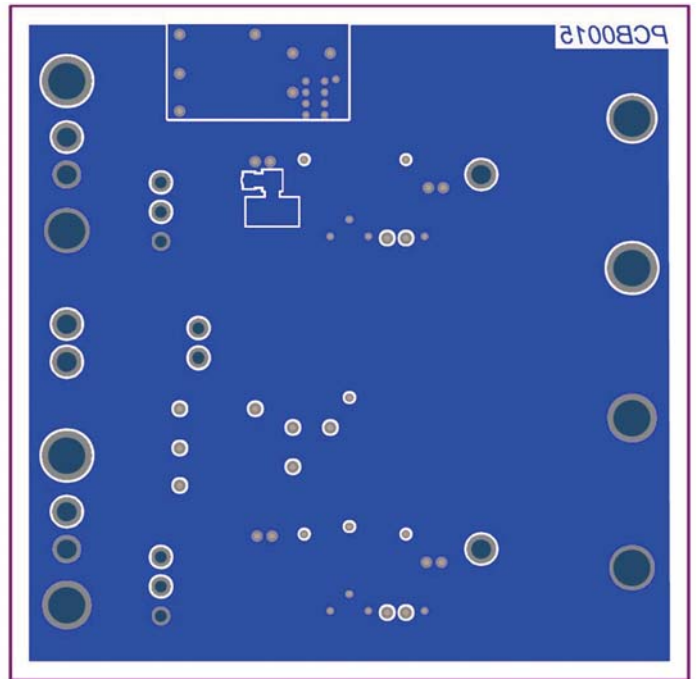
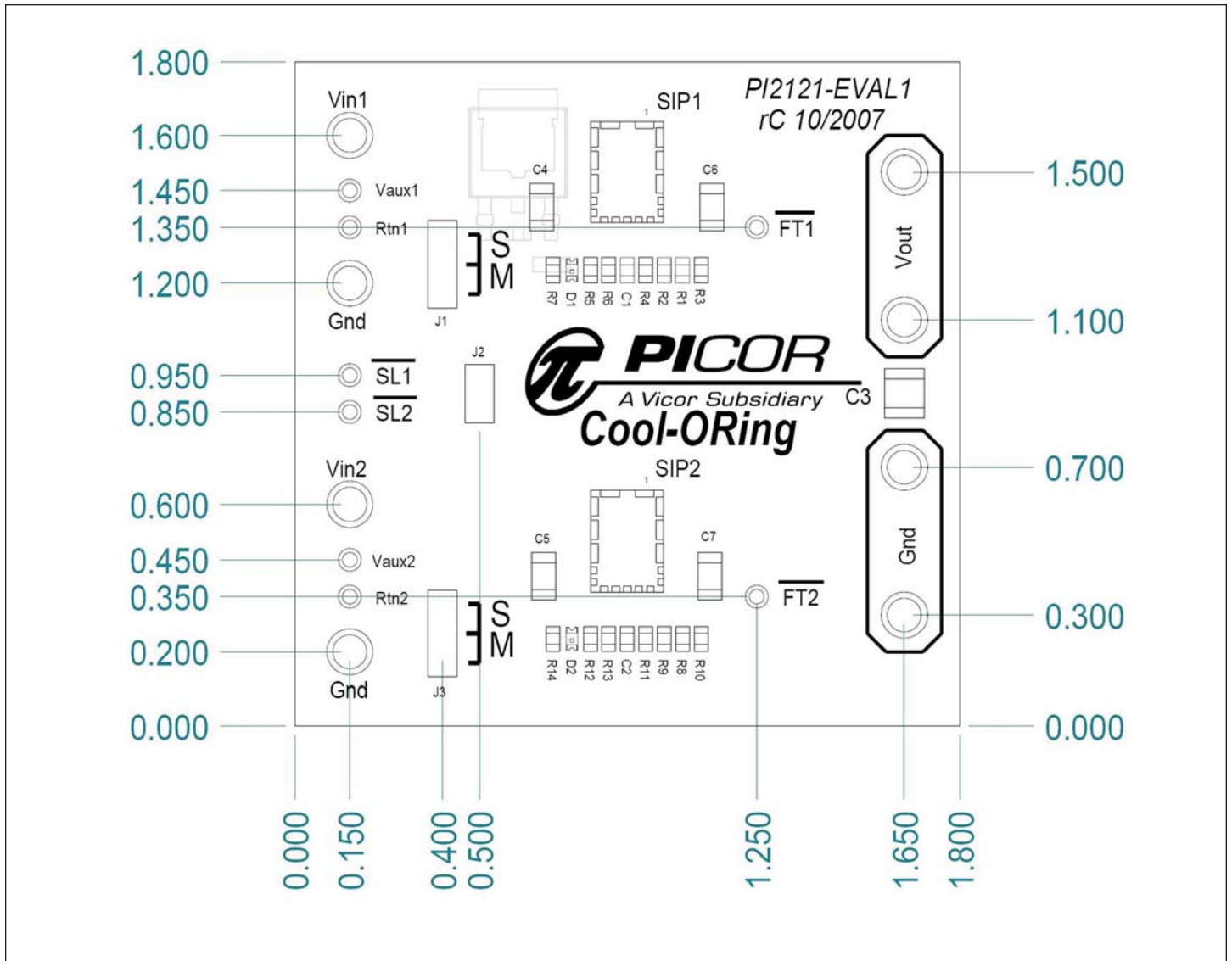


Figure 8d – PI2121-EVAL1 layout Bottom layer. Scale 2.0:1

Mechanical Drawing



Vicor's comprehensive line of power solutions includes high-density AC-DC & DC-DC modules and accessory components, fully configurable AC-DC & DC-DC power supplies, and complete custom power systems.

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